

MEI**ULTRA FAST GLASS PASSIVATED RECTIFIER**

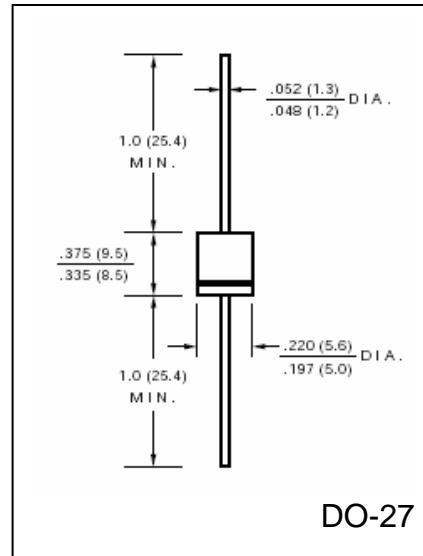
UF3001G THRU UF3007G

VOLTAGE RANGE
CURRENT50 to 1000 Volts
3.0 Ampere**FEATURES**

- Fast switching speed for high efficiency
- Glass passivated chip junction
- Low reverse leakage
- High forward surge current capacity
- High temperature soldering guaranteed:
260 /10 seconds, 0.375" (9.5mm) lead length

MECHANICAL DATA

- Case: transfer molded plastic
- Epoxy: UL94V – 0 rate flame retardant
- Polarity: Color band denotes cathode end
- Lead: Plated axial lead, solderable per MIL-STD-202E method 208C
- Mounting position: any
- Weight: 0.042 ounce, 1.19 gram

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

- Ratings at 25°C ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

	SYMBOLS	UF 3001G	UF 3002G	UF 3003G	UF 3004G	UF 3005G	UF 3006G	UF 3007G	UNIT
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current, 0.375" (9.5mm) lead length At T _A = 55°C	I _(AV)					3.0			Amps
Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load (JEDEC method)	I _{FSM}				150				Amps
Maximum Instantaneous Forward Voltage @ 3.0A	V _F			1.0		1.7			Volts
Maximum DC Reverse Current at Rated T _A = 25 °C	I _R				10				µA
DC Blocking Voltage per element T _A = 125 °C					100				
Maximum Reverse Recovery Time Test conditions I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A	t _{rr}			50		75			nS
Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V)	C _J			45					pF
Typical Thermal Resistance (Note 1)	R _{θJA}			20					°C/W
Operating Junction Temperature Range	T _J			(-55 to +150)					°C
Storage Temperature Range	T _{STG}			(-55 to +150)					°C

Notes:

1. Thermal resistance from junction to ambient with 0.375" (9.5mm) lead length, PCB mounted

FIG.1—TYPICAL FORWARD CURRENT DERATING CURVE

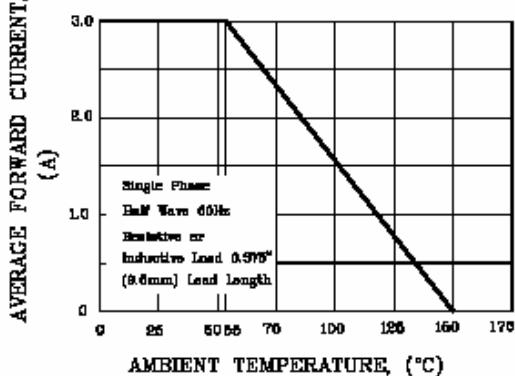


FIG.3—TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

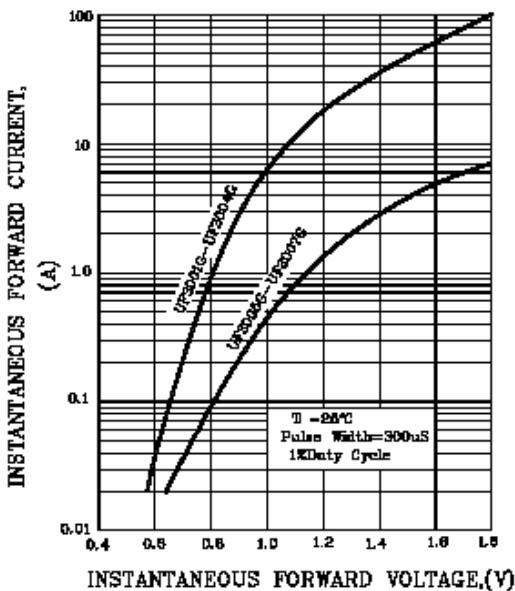


FIG.5—TYPICAL JUNCTION CAPACITANCE

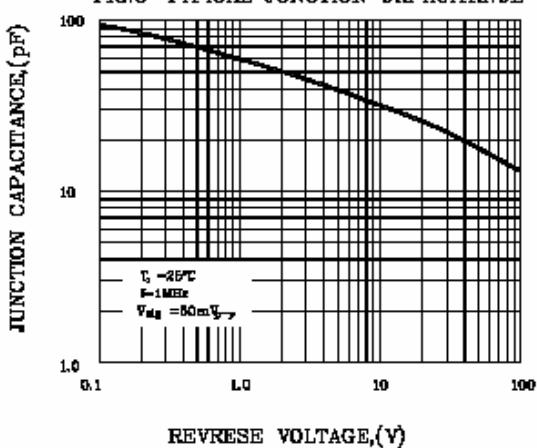


FIG.2—MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

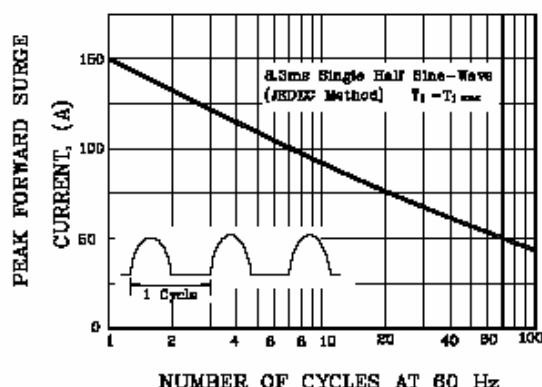


FIG.4—TYPICAL REVERSE CHARACTERISTICS

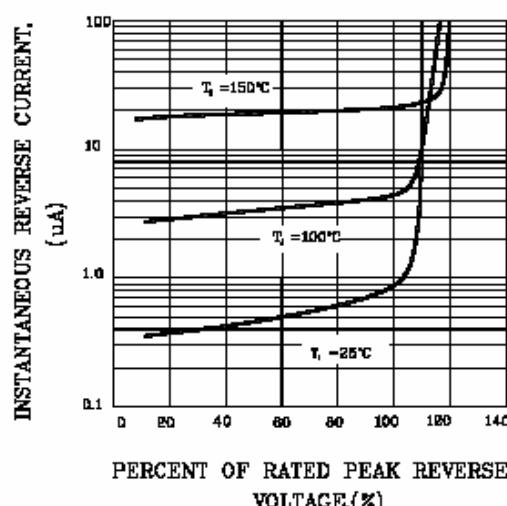


FIG.6—TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

